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From the INTERNATIONAL SEARCHING AUTHORITY

PCT

NOTIFICATION OF TRANSMITTAL OF
THE INTERNATIONAL SEARCH REPORT
OR THE DECLARATION

(PCT Rule 44.1)

To:

INTERNATIONAAL OCTROOIBUREAU B.V.
Attn. DUIJVESTIJD, Adrianus J
Prof. Holstlaan 6
5656 AA Eindhoven
NETHERLANDS

NOLL

Date of mailing
(day/month/year)

16/11/2001

Applicant's or agent's file reference

PHJP000010W0

FOR FURTHER ACTION

See paragraphs 1 and 4 below

International application No.

PCT/EP 01/06294

International filing date
(day/month/year)

31/05/2001

Applicant

KONINKLIJKE PHILIPS ELECTRONICS N.V.

- 1.
- ☒
- The applicant is hereby notified that the International Search Report has been established and is transmitted herewith.

Filing of amendments and statement under Article 19:

The applicant is entitled, if he so wishes, to amend the claims of the International Application (see Rule 46):

When? The time limit for filing such amendments is normally 2 months from the date of transmittal of the International Search Report; however, for more details, see the notes on the accompanying sheet.**Where?** Directly to the International Bureau of WIPO
34, chemin des Colombettes
1211 Geneva 20, Switzerland
Facsimile No.: (41-22) 740.14.35**For more detailed instructions,** see the notes on the accompanying sheet.

- 2.
- ☐
- The applicant is hereby notified that no International Search Report will be established and that the declaration under Article 17(2)(a) to that effect is transmitted herewith.

- 3.
- ☐
- With regard to the protest**
- against payment of (an) additional fee(s) under Rule 40.2, the applicant is notified that:

☐ the protest together with the decision thereon has been transmitted to the International Bureau together with the applicant's request to forward the texts of both the protest and the decision thereon to the designated Offices.☐ no decision has been made yet on the protest; the applicant will be notified as soon as a decision is made.

- 4.
- Further action(s):**
- The applicant is reminded of the following:

Shortly after **18 months** from the priority date, the international application will be published by the International Bureau. If the applicant wishes to avoid or postpone publication, a notice of withdrawal of the international application, or of the priority claim, must reach the International Bureau as provided in Rules 90bis.1 and 90bis.3, respectively, before the completion of the technical preparations for international publication.Within **19 months** from the priority date, a demand for international preliminary examination must be filed if the applicant wishes to postpone the entry into the national phase until 30 months from the priority date (in some Offices even later).Within **20 months** from the priority date, the applicant must perform the prescribed acts for entry into the national phase before all designated Offices which have not been elected in the demand or in a later election within 19 months from the priority date or could not be elected because they are not bound by Chapter II.

Name and mailing address of the International Searching Authority

European Patent Office, P.B. 5818 Patentlaan 2
NL-2280 HV Rijswijk
Tel. (+31-70) 340-2040, Tx. 31 651 epo nl,
Fax: (+31-70) 340-3016

Authorized officer

Toñi Muñoz-Manneken

NOTES TO FORM PCT/ISA/220

These Notes are intended to give the basic instructions concerning the filing of amendments under article 19. The Notes are based on the requirements of the Patent Cooperation Treaty, the Regulations and the Administrative Instructions under that Treaty. In case of discrepancy between these Notes and those requirements, the latter are applicable. For more detailed information, see also the PCT Applicant's Guide, a publication of WIPO.

In these Notes, "Article", "Rule", and "Section" refer to the provisions of the PCT, the PCT Regulations and the PCT Administrative Instructions respectively.

INSTRUCTIONS CONCERNING AMENDMENTS UNDER ARTICLE 19

The applicant has, after having received the international search report, one opportunity to amend the claims of the international application. It should however be emphasized that, since all parts of the international application (claims, description and drawings) may be amended during the international preliminary examination procedure, there is usually no need to file amendments of the claims under Article 19 except where, e.g. the applicant wants the latter to be published for the purposes of provisional protection or has another reason for amending the claims before international publication. Furthermore, it should be emphasized that provisional protection is available in some States only.

What parts of the international application may be amended?

Under Article 19, only the claims may be amended.

During the international phase, the claims may also be amended (or further amended) under Article 34 before the International Preliminary Examining Authority. The description and drawings may only be amended under Article 34 before the International Examining Authority.

Upon entry into the national phase, all parts of the international application may be amended under Article 28 or, where applicable, Article 41.

When?

Within 2 months from the date of transmittal of the international search report or 16 months from the priority date, whichever time limit expires later. It should be noted, however, that the amendments will be considered as having been received on time if they are received by the International Bureau after the expiration of the applicable time limit but before the completion of the technical preparations for international publication (Rule 46.1).

Where not to file the amendments?

The amendments may only be filed with the International Bureau and not with the receiving Office or the International Searching Authority (Rule 46.2).

Where a demand for international preliminary examination has been/is filed, see below.

How?

Either by cancelling one or more entire claims, by adding one or more new claims or by amending the text of one or more of the claims as filed.

A replacement sheet must be submitted for each sheet of the claims which, on account of an amendment or amendments, differs from the sheet originally filed.

All the claims appearing on a replacement sheet must be numbered in Arabic numerals. Where a claim is cancelled, no renumbering of the other claims is required. In all cases where claims are renumbered, they must be renumbered consecutively (Administrative Instructions, Section 205(b)).

The amendments must be made in the language in which the international application is to be published.

What documents must/may accompany the amendments?

Letter (Section 205(b)):

The amendments must be submitted with a letter.

The letter will not be published with the international application and the amended claims. It should not be confused with the "Statement under Article 19(1)" (see below, under "Statement under Article 19(1)").

The letter must be in English or French, at the choice of the applicant. However, if the language of the international application is English, the letter must be in English; if the language of the international application is French, the letter must be in French.

NOTES TO FORM PCT/ISA/220 (continued)

The letter must indicate the differences between the claims as filed and the claims as amended. It must, in particular, indicate, in connection with each claim appearing in the international application (it being understood that identical indications concerning several claims may be grouped), whether

- (i) the claim is unchanged;
- (ii) the claim is cancelled;
- (iii) the claim is new;
- (iv) the claim replaces one or more claims as filed;
- (v) the claim is the result of the division of a claim as filed.

The following examples illustrate the manner in which amendments must be explained in the accompanying letter:

1. [Where originally there were 48 claims and after amendment of some claims there are 51]:
"Claims 1 to 29, 31, 32, 34, 35, 37 to 48 replaced by amended claims bearing the same numbers; claims 30, 33 and 36 unchanged; new claims 49 to 51 added."
2. [Where originally there were 15 claims and after amendment of all claims there are 11]:
"Claims 1 to 15 replaced by amended claims 1 to 11."
3. [Where originally there were 14 claims and the amendments consist in cancelling some claims and in adding new claims]:
"Claims 1 to 6 and 14 unchanged; claims 7 to 13 cancelled; new claims 15, 16 and 17 added." or
"Claims 7 to 13 cancelled; new claims 15, 16 and 17 added; all other claims unchanged."
4. [Where various kinds of amendments are made]:
"Claims 1-10 unchanged; claims 11 to 13, 18 and 19 cancelled; claims 14, 15 and 16 replaced by amended claim 14; claim 17 subdivided into amended claims 15, 16 and 17; new claims 20 and 21 added."

"Statement under article 19(1)" (Rule 46.4)

The amendments may be accompanied by a statement explaining the amendments and indicating any impact that such amendments might have on the description and the drawings (which cannot be amended under Article 19(1)).

The statement will be published with the international application and the amended claims.

It must be in the language in which the international application is to be published.

It must be brief, not exceeding 500 words if in English or if translated into English.

It should not be confused with and does not replace the letter indicating the differences between the claims as filed and as amended. It must be filed on a separate sheet and must be identified as such by a heading, preferably by using the words "Statement under Article 19(1)."

It may not contain any disparaging comments on the international search report or the relevance of citations contained in that report. Reference to citations, relevant to a given claim, contained in the international search report may be made only in connection with an amendment of that claim.

Consequence if a demand for international preliminary examination has already been filed

If, at the time of filing any amendments under Article 19, a demand for international preliminary examination has already been submitted, the applicant must preferably, at the same time of filing the amendments with the International Bureau, also file a copy of such amendments with the International Preliminary Examining Authority (see Rule 62.2(a), first sentence).

Consequence with regard to translation of the international application for entry into the national phase

The applicant's attention is drawn to the fact that, where upon entry into the national phase, a translation of the claims as amended under Article 19 may have to be furnished to the designated/elected Offices, instead of, or in addition to, the translation of the claims as filed.

For further details on the requirements of each designated/elected Office, see Volume II of the PCT Applicant's Guide.

PCT

INTERNATIONAL SEARCH REPORT

(PCT Article 18 and Rules 43 and 44)

Applicant's or agent's file reference PHJP000010W0	FOR FURTHER ACTION see Notification of Transmittal of International Search Report (Form PCT/ISA/220) as well as, where applicable, item 5 below.	
International application No. PCT/EP 01/ 06294	International filing date (day/month/year) 31/05/2001	(Earliest) Priority Date (day/month/year) 31/05/2000
Applicant KONINKLIJKE PHILIPS ELECTRONICS N.V.		

This International Search Report has been prepared by this International Searching Authority and is transmitted to the applicant according to Article 18. A copy is being transmitted to the International Bureau.

This International Search Report consists of a total of 3 sheets.



It is also accompanied by a copy of each prior art document cited in this report.

1. Basis of the report

- a. With regard to the **language**, the international search was carried out on the basis of the international application in the language in which it was filed, unless otherwise indicated under this item.



the international search was carried out on the basis of a translation of the international application furnished to this Authority (Rule 23.1(b)).

- b. With regard to any **nucleotide and/or amino acid sequence** disclosed in the international application, the international search was carried out on the basis of the sequence listing :



contained in the international application in written form.



filed together with the international application in computer readable form.



furnished subsequently to this Authority in written form.



furnished subsequently to this Authority in computer readable form.



the statement that the subsequently furnished written sequence listing does not go beyond the disclosure in the international application as filed has been furnished.



the statement that the information recorded in computer readable form is identical to the written sequence listing has been furnished

2. ☐ **Certain claims were found unsearchable** (See Box I).

3. ☐ **Unity of invention is lacking** (see Box II).

4. With regard to the **title**,



the text is approved as submitted by the applicant.



the text has been established by this Authority to read as follows:

5. With regard to the **abstract**,



the text is approved as submitted by the applicant.



the text has been established, according to Rule 38.2(b), by this Authority as it appears in Box III. The applicant may, within one month from the date of mailing of this international search report, submit comments to this Authority.

6. The figure of the **drawings** to be published with the abstract is Figure No.



as suggested by the applicant.



because the applicant failed to suggest a figure.



because this figure better characterizes the invention.



None of the figures.

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(NL). **KOBAYASHI, Masatoshi** [JP/NL]; Prof. Holstlaan
6, NL-5656 AA Eindhoven (NL).

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(74) Agent: **DUIJVESTIJN, Adrianus, J.**; Internationaal Oc-
trooibureau B.V., Prof Holstlaan 6, NL-5656 AA Eind-
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(71) Applicant (*for AT, BE, CH, CN, CY, DE, DK, ES, FI, FR,
GB, GR, IE, IT, LU, MC, NL, PT, SE, TR only*): **KONIN-
KLIJKE PHILIPS ELECTRONICS N.V.** [NL/NL];
Groenewoudseweg 1, NL-5621 BA Eindhoven (NL).

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- with international search report
- before the expiration of the time limit for amending the
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(72) Inventors; and

(75) Inventors/Applicants (*for US only*): **MASUMURA, Hi-
toshi** [JP/NL]; Prof. Holstlaan 6, NL-5656 AA Eindhoven

*For two-letter codes and other abbreviations, refer to the "Guid-
ance Notes on Codes and Abbreviations" appearing at the begin-
ning of each regular issue of the PCT Gazette.*

(54) Title: A DIELECTRIC CERAMIC COMPOSITE

(57) Abstract: The invention provides a dielectric ceramic composite that can be burnt at a low temperature. The dielectric ceramic composite in accordance with the invention is produced by means of adding eight kinds of chemical compounds of ZnO, SiO₂, CuO, Al₂O₃, MgO, BaCO₃, B₂O₃ and Bi₂O₃ to (BaNdSm) TiO₃ and then wet-mixing them for three hours.

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A dielectric ceramic composite

Technical Field

The invention relates to a dielectric ceramic composite containing (BaNdSm)TiO₃, and to an electronic device.

5 Background of the Invention

In recent years, in the field of the high frequency equipments such as mobile phones, their size has become smaller, their performance has become higher and their price has become lower. According to such tendency, a smaller size, high-performance and less expensive price are also desired for dielectric resonators that are used in such high frequency equipments. In particular, a high relative dielectric constant and a high Q factor are required for dielectric ceramic composites that are used as materials for those dielectric resonators. A dielectric ceramic composite that meets such requirement is disclosed in Japan Patent Application Laid-Open No. 1995-104949. If dielectric ceramic composites in accordance with the above-referenced patent application are used to produce, for example, multi-layer ceramic capacitors, it is possible to obtain capacitors having good characteristics.

As materials of internal electrodes formed in the multi-layer ceramic capacitors, precious metals such as Pd, Pt and Au are used. However, if those precious metals are used as materials for the internal electrodes, there exists a problem that the material cost may become expensive. Accordingly, the use of less expensive metals such Ag may be considered instead of the use of the precious metals. However, the melting point of the Ag is about 960 °C whereas the sintering temperature for the dielectric ceramic composite disclosed in the above-referenced patent application is close to 1400 °C. So, if a multi-layer ceramic capacitor is produced by combination of the Ag with the dielectric ceramic composite disclosed in the above-referenced patent application, there is a problem that the Ag may be melted out during the sintering process of the dielectric ceramic composite.

In view of the above-described background, it is an objective of the invention to provide a dielectric ceramic composite that can be sintered at a low temperature.

Summary of the Invention

In order to achieve the above-described objective, the dielectric ceramic composite according to the present invention is characterised by comprising (BaNdSm)TiO₃, ZnO, SiO₂, CuO, Al₂O₃, MgO, B₂O₃, Bi₂O₃ and either BaCO₃ or BaO. By including these materials, it becomes possible to sinter the dielectric ceramic composite at a low temperature.

5 In the dielectric ceramic composite according to the present invention, the total weight of the said ZnO, SiO₂, CuO, Al₂O₃, MgO, B₂O₃, Bi₂O₃ and either BaCO₃ or BaO is preferably about 20% through 30% of the weight of the said (BaNdSm)TiO₃. Additionally, a ratio of the total weight of the said ZnO, SiO₂, CuO, Al₂O₃, MgO, B₂O₃ and either BaCO₃ or BaO with the weight of the said Bi₂O₃ is preferably in a range of 0.67 to 1.50. Such the
10 total weight or the ratio is possible to realize the high relative dielectric constant and the high Q factor.

Furthermore, in the inventive dielectric ceramic composite, the average of the grain sizes of the said SiO₂, CuO and Al₂O₃ is preferably no more than 30 nm. With such size of the grains, it becomes possible to sinter the dielectric ceramic composite at a further lower
15 temperature.

Detailed Description of the Invention

As examples of the dielectric ceramic composite in accordance with the invention, the 1st to the 17th embodiments of the dielectric ceramic composite that are
20 appropriate materials for single planar capacitors will be described in the following. Each of the 1st to the 17th embodiments of dielectric ceramic composites mainly contains the ceramic composite "(BaNdSm)TiO₃" comprising Ba (barium), Ti (titanium), Nd (neodymium) and Sm (samarium). Furthermore, in each dielectric ceramic composite, ZnO, SiO₂, CuO, Al₂O₃, MgO, BaO, B₂O₃ and Bi₂O₃ are added to the ceramic composite (BaNdSm)TiO₃. The
25 method of manufacturing the 1st to the 17th embodiments of the dielectric ceramic composites will below explained.

In manufacturing the 1st to the 17th embodiments of the dielectric ceramic composites, a ceramic composite (BaNdSm)TiO₃ mainly contained in the dielectric ceramic composite is first manufactured as explained below.

30 Firstly, BaCO₃, Nd₂O₃, Sm₂O₃ and TiO₂ are chosen as starting materials. And the each required quantity of the BaCO₃, Nd₂O₃, Sm₂O₃ and TiO₂ was weighed. In these embodiments, for BaCO₃, Nd₂O₃, Sm₂O₃ and TiO₂, 18mol%, 11mol%, 4mol% and 67mol% are weighed respectively. After having been weighed, these weighed materials are wet-blended for three hours using zirconium beads (in the wet-blending, water is used as

solvent) and then these blended materials are dried out. Thereafter, a mixture of BaCO₃, Nd₂O₃, Sm₂O₃ and TiO₂ obtained in such a manner are calcined for two hours at a temperature of 1,170 °C. Then, the calcined materials are wet-ground for three hours using zirconium beads (in the wet-grinding, water is used as solvent) and then the ground materials are dried out. Thus, a (BaNdSm)TiO₃ is manufactured.

In the next step, eight kinds of compounds of ZnO, SiO₂, CuO, Al₂O₃, MgO, BaCO₃, B₂O₃ and Bi₂O₃ (hereinafter, ZnO, SiO₂, CuO, Al₂O₃, MgO, BaCO₃, B₂O₃ and Bi₂O₃ may be simply referred to as “eight kinds of compounds A”) are added to the manufactured (BaNdSm)TiO₃, and then those materials are wet-blended for three hours. In the instant example, the 1st to 17th embodiments of the dielectric ceramic composites D1 to D17 are manufactured by changing the mixture rates and the grain sizes of the each compound of “the eight kinds of the compound A”. Table 1 shows the compositions of the dielectric ceramic composites D1 to D12 of the 1st to 12th embodiments and Table 2 shows the compositions of the dielectric ceramic composites D13 to D17 of the 13th to 17th embodiments.

[Table 1]

[Table 2]

Table 1 shows the weight% of each compound added to the (BaNdSm)TiO₃ when the weight% of the (BaNdSm)TiO₃ is defined as “100”. In Table 1, for the dielectric ceramic composites D1 to D5, seven kinds of compounds of ZnO, SiO₂, CuO, Al₂O₃, MgO, BaCO₃ and B₂O₃ (hereinafter, ZnO, SiO₂, CuO, Al₂O₃, MgO, BaCO₃ and B₂O₃ may be simply referred to as “seven kinds of compounds B”) are added to the (BaNdSm)TiO₃ by 10% in weight relative to the (BaNdSm)TiO₃. The remaining compound Bi₂O₃ (hereinafter, the compound Bi₂O₃ may be referred to as “one kind of compound C”) is also added to the (BaNdSm)TiO₃ by 10% in weight relative to the (BaNdSm)TiO₃. However, the respective weight% of each compound of “seven kinds of the compounds B” varies with each of the embodiments D1 to D5.

Besides, in all of the dielectric ceramic composites D1 and D6 through D12 of the 1st and the 6th through 12th embodiments, the ratio of addition of “seven kinds of compounds B” is ZnO : SiO₂ : CuO : Al₂O₃ : MgO : BaCO₃ : B₂O₃ = 27.9 : 22.4 : 5.0 : 10.1 : 3.0 : 25.9 : 5.7. However, weight% of the “seven kinds of compounds B” as a whole vary with the dielectric ceramic composites D1 and D6 through D12, or the B/Cs representing the

weight% ratio of “seven kinds of compounds B” and “one kind of compound C” vary with the dielectric ceramic composites D1 and D6 through D12.

Table 1 also shows the average of the grain sizes for each of ZnO, SiO₂, CuO, Al₂O₃, MgO, BaCO₃, B₂O₃ and Bi₂O₃. The average of the grain sizes for Bi₂O₃ is not shown because Bi₂O₃ dissolves into water.

With respect to the dielectric ceramic composites D13 through D17 of the 13th through 17th embodiments shown in Table 2, the weight % of each compound equals to that of the dielectric ceramic composite D1 of the 1st embodiment but the grain size of each compound is different from that of the dielectric ceramic composite D1. Table 2 shows the grain sizes (nm) for each of the compounds used in the dielectric ceramic composites D13 through D17. Further, Table 2 also shows the grain sizes (nm) for compounds used in the dielectric ceramic composite D1.

Now, the method of manufacturing a single planar capacitor using the dielectric ceramic composites D1 through D17 will be explained. Firstly, each of the dielectric ceramic composites D1 to D17 is wet-blended for three hours using zirconium beads (in the wet-blending, water is used as solvent). And next, each of blended dielectric ceramic composites D1 to D17 is dried out, and each of dried dielectric ceramic composites D1 to D17 is ground into dried powder. Then, each of the dielectric ceramic composites D1 through D17 in dried powder is granulated while adding PVA (polyvinyl alcohol) as a binder. After granulating each of the dielectric ceramic composites D1 to D17, each of the granulated dielectric ceramic composites D1 to D17 is charged into the mold with the 16.5mmΦ and is molded by means of a presser by a pressure of 3 tons per square centimeter. In such way, disk-like samples having a thickness of 0.7 mm are manufactured for each of the dielectric ceramic composites D1 to D17. Thereafter, these disk-like samples are sintered for two hours in the air at the temperature of 880 to 930 °C and an Ag paste is printed on each of the sintered samples and then each of the printed samples is baked at the temperature of 750 °C. Thus, single planar capacitors are manufactured.

The dielectric ceramic composites of the 1st through 17th embodiments can be sintered at the temperature of about 900 °C that is lower than the sintering temperature for the conventional dielectric ceramic composites, so that the low temperature sintering can be realized.

As described above, the dielectric ceramic composites of the 1st through 17th embodiments are used to manufacture the single planar capacitor. However, the dielectric

ceramic composite according to the present invention may be used to manufacture any other electronic devices than the single planar capacitor.

Examples of other electronic devices include ceramic multilayer capacitors, filters networks of passive components comprising planar capacitors as well as multilayer substrates, like a LTCC-substrate or a laminate. The construction of such devices is generally known per se by the person skilled in the art, various are present in the patent literature. The dielectric composite, especially in the preferred embodiment with a grain size of less than 50 nm, is very well suited for the application in substrates. First of all, it can be sintered at a temperature lower than the melting point of Cu, which is a standard electrode material in these substrates. Secondly, due to the grain size it can be mixed very well with other substituents of the substrate, such as epoxy in the case of a laminate. Thirdly, due to the high Q-factor, an electronic device with composite of the invention can be applied under high-frequency conditions, such as in telecom applications.

Moreover, although the dielectric ceramic composites of the 1st through 17th embodiments contain BaCO₃ in the instant example, for example BaO can be used as an alternative to BaCO₃. However, since BaO is an unstable material, it may be easier to manufacture the dielectric ceramic composites by using BaCO₃ rather than BaO.

From now on, reference is made to Table 1 to 3 for explaining some embodiment examples of the invention. At first, embodiment examples 1 to 21 of single planar capacitors were manufactured using the dielectric ceramic composites D1 to D17 of the 1st to 17th embodiments. Table 3 shows electric characteristics of each of embodiment examples 1 to 21 of single planar capacitors.

[Table 3]

The embodiment examples 1 to 5 in Table 3 are respective single planar capacitors that were manufactured by sintering the dielectric ceramic composites D1 of the 1st embodiment at the respective temperatures 870, 880, 900, 910 and 930 °C. The embodiment examples 6 to 16 in Table 3 are respective single planar capacitors that were manufactured by sintering the respective dielectric ceramic composites D2 to D12 of the 2nd to 12th embodiments at the temperature of 910 °C. The examples 17 to 21 in Table 3 are respective single planar capacitors that were manufactured by sintering the respective dielectric ceramic composites D13 to D17 of the 13th to 17th embodiments at the temperature of 930 °C.

Relative dielectric constants and Q factors for each of the single planar capacitors are measured using an automatic bridge-type measuring equipment in a condition of 1 MHz, 1 V_{rms}. Besides, temperature dependencies of capacitance TC(ppm/degree C) shown in Table 3 are temperature dependencies at the temperature of -55 to +125 °C with reference to the capacitance at the temperature of +25 °C.

Referring to embodiment examples 1 to 5, it is observed that capacitors having different characteristics can be manufactured by changing the sintering temperature although these examples are used the same dielectric ceramic composite D1. Now, considering a case, for example, where a capacitor is to be applied to a capacitor component of a resonator, the capacitor should preferably have such characteristics that the relative dielectric constant be no less than 70, the Q factor be no less than 2000 and the TC be within +/- 30(ppm/°C). Embodiment examples 2 to 5 of single planar capacitors have such characteristics that the relative dielectric constant is no less than 70, the Q factor is no less than 2000 and the TC is within +/- 30(ppm/°C). The sintering temperature for the embodiment examples 2 to 5 is 880 to 930 °C. Thus, it is found that capacitors appropriate for the capacitor component of the resonator could be obtained by using the temperature of 880 to 930 °C.

Next, referring to embodiment examples 4 and 6 to 9, it can be observed that all of the single planar capacitors are appropriate for the capacitor component of the resonator since all of the single planar capacitors have the characteristics that the relative dielectric constant is no less than 70, the Q factor is no less than 2000 and the TC is within +/- 30(ppm/°C). As for the dielectric ceramic composites D1 to D5 that are used for each of the single planar capacitors of the embodiment examples 4 and 6 to 9, the weight% of the "seven kinds of the compounds B" added to (BaNdSm)TiO₃ is all equivalent (10%) as shown in Table 1 but the ratio of each compound added to the (BaNdSm)TiO₃ is different in each embodiment. Therefore, for the purpose of obtaining capacitors which are appropriate for the capacitor component of the resonator, the ratio of each of compounds contained in the dielectric ceramic composite is not limited to a specific value. As a result, it can be observed that it is possible to obtain the capacitors appropriate for the capacitor component of the resonator even if the ratio of each of compounds contained in the dielectric ceramic composite is changed.

Referring to embodiment examples 4 and 10 to 12, their sintering temperatures are equally 910 °C, and further the B/Cs for the dielectric ceramic composites D1 and D6 to D8 used in capacitors of embodiment examples 4 and 10 to 12 are equally 1 (refer to Table

1). However, weight% of B+C for the dielectric ceramic composites D1 and D6 to D8 are different each other. To be more specific, the weight % of the B+C is 20% for the dielectric ceramic composite D1 used in the embodiment example 4, the weight % of the B+C is 10% for the dielectric ceramic composite D6 used in the embodiment example 10, the weight % of the B+C is 30% for the dielectric ceramic composite D7 used in the embodiment example 11, and the weight % of the B+C is 40% for the dielectric ceramic composite D8 used in the embodiment example 12. It is observed that the single planer capacitors of the embodiment examples 4 and 11 using the dielectric ceramic composites D1 and D7 (their weight ratio of B+C is within 20-30%) have the characteristics that the relative dielectric constant is no less than 70, the Q factor is no less than 2000 and the TC is within +/- 30(ppm/°C). Therefore, it is possible to manufacture capacitors that are appropriate for the capacitor component of the resonator by keeping the weight% of B+C within 20-30%.

Referring to embodiment examples 4 and 13 to 16, although their sintering temperatures are equally 910 °C, the B/Cs of the dielectric ceramic composites D1, D9 to D12 that are used therein are different each other. To be more specific, the B/C is 1 for the dielectric ceramic composite D1 and the respective B/Cs is 1.5, 2.3, 0.67 and 0.43 for the dielectric ceramic composites D9 to D12 that are used for the embodiment examples 13-16, respectively. Among the single planar capacitors of the embodiment examples 4 and 13 to 16, the single planar capacitors of the embodiment examples 4, 13 and 15 that use the dielectric ceramic composites D1, D9 and D11 having the B/C weight % in the range of 0.67 to 1.5 show acceptable characteristics that the relative dielectric constant is no less than 70, the Q factor is no less than 2000 and the TC is within +/- 30(ppm/°C). Therefore, it is possible to manufacture capacitors that are appropriate for the capacitor component of the resonator by keeping the B/C weight % in the range of 0.67 to 1.5.

Finally, referring to embodiment examples 5 and 17 to 21, although their sintering temperatures are equally 930 °C, the grain sizes of SiO₂, CuO and Al₂O₃ of the dielectric ceramic composites D1, D13 to D17 that are used therein are different each other (see Table 2). Among the single planar capacitors of the embodiment examples 5 and 17 to 21, the single planar capacitors of the embodiment example 5 that uses the dielectric ceramic composites D1 having SiO₂, CuO and Al₂O₃ with their grain sizes within no more than 30 nm show acceptable characteristics that the relative dielectric constant is no less than 70, the Q factor is no less than 2000 and the TC is within +/- 30(ppm/°C). Therefore, it is possible to manufacture capacitors that are appropriate for the capacitor component of the resonator by keeping the grain sizes of SiO₂, CuO and Al₂O₃ within no more than 30 nm.

As described above, the invention provides a dielectric ceramic composite that can be sintered at a low temperature.

CLAIMS:

1. A dielectric ceramic composite characterised by comprising (BaNdSm)TiO₃, ZnO, SiO₂, CuO, Al₂O₃, MgO, B₂O₃, Bi₂O₃ and either BaCO₃ or BaO.
2. A dielectric ceramic composite as claimed in claim 1, characterized in that the
5 total weight of the said ZnO, SiO₂, CuO, Al₂O₃, MgO, B₂O₃, Bi₂O₃ and either BaCO₃ or BaO is about 20% through 30% of the weight of the said (BaNdSm)TiO₃.
3. A dielectric ceramic composite as claimed in claim 2, characterized in that a
10 ratio of the total weight of the said ZnO, SiO₂, CuO, Al₂O₃, MgO, B₂O₃ and either BaCO₃ or BaO with the weight of the said Bi₂O₃ is in a range of 0.67 to 1.50.
4. A dielectric ceramic composite as claimed in claim 2 or 3, characterized in that
the average of the grain sizes of the said SiO₂, CuO and Al₂O₃ is no more than 30 nm.
- 15 5. An electronic device comprising the dielectric ceramic composite according to one of the claims 1-4

INTERNATIONAL SEARCH REPORT

International Application No

PCT/EP 01/06294

A. CLASSIFICATION OF SUBJECT MATTER

IPC 7 C04B35/468 H01B3/12 H01G4/12 C04B35/462 C01G23/00

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC 7 C04B H01B H01G C01G

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

EPO-Internal, PAJ, WPI Data, CHEM ABS Data, COMPENDEX, INSPEC

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	EP 0 973 173 A (TDK CORP) 19 January 2000 (2000-01-19) example 4; tables 5,2	1-5
A	DE 198 41 487 A (SIEMENS MATSUSHITA COMPONENTS) 23 March 2000 (2000-03-23) page 3, line 30 -page 4, line 55; table 1 page 5, line 8-13; tables 2-4	1-5
A	EP 0 701 981 A (UBE INDUSTRIES) 20 March 1996 (1996-03-20) comparative examples 27,28 tables 3,4	1-5
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☒ Further documents are listed in the continuation of box C.☒ Patent family members are listed in annex.

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- * & * document member of the same patent family

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Name and mailing address of the ISA

European Patent Office, P.B. 5818 Patentlaan 2
NL - 2280 HV Rijswijk
Tel. (+31-70) 340-2040, Tx. 31 651 epo nl,
Fax: (+31-70) 340-3016

Authorized officer

Raming, T

INTERNATIONAL SEARCH REPORT

International Application No

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C.(Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	<p>PATENT ABSTRACTS OF JAPAN vol. 017, no. 230 (E-1361), 11 May 1993 (1993-05-11) -& JP 04 359806 A (MATSUSHITA ELECTRIC IND CO LTD), 14 December 1992 (1992-12-14) abstract</p>	1-5

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Information on patent family members

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